

PRODUCT FAMILY DATA SHEET

Cree[®] XLamp[®] XM-L Color LEDs



PRODUCT DESCRIPTION

The XLamp XM-L Color LED is a multi-color LED that provides high lumen output in a small package. Compared to discrete LEDs, XLamp XM-L Color LEDs reduce the distance between LED die, creating a small optical source for excellent optical control and efficient color mixing. XLamp XM-L Color LEDs can reduce LED system complexity by reducing the number of components required.

XM-L Color LEDs Cree XLamp performance and bring high quality of light to a wide range of lighting applications, including color-changing lighting, stage lighting, architectural lighting, indoor directional lighting, and entertainment lighting.

FEATURES

- Available in red, green, blue and white in a single 5 mm x 5 mm package
- Maximum drive current per LED die: 1 A
- Individually addressable LEDs
- Reflow solderable JEDEC
 J-STD-020
- Electrically neutral thermal path

TABLE OF CONTENTS

Flux Characteristics 2
Characteristics - Complete
Package 2
Characteristics - Per LED Die 3
Relative Spectral Power
Distribution 3
Relative Flux vs Junction
Temperature 4
Electrical Characteristics 4
Relative Flux vs. Current 5
Typical Spatial Distribution 5
Bin and Order-Code Formats 6
Performance Groups – Brightness 6
Performance Groups –
Chromaticity 7
Performance Groups – Dominant
Wavelength 7
Standard Order Codes and $Bins \dots 8$
Reflow Soldering Characteristics 9
Mechanical Dimensions10
Tape and Reel11
Packaging12



FLUX CHARACTERISTICS, (T₁ = 25 °C)

The following tables provide several base order codes for XM-L Color LEDs. For a complete description of the order code nomenclature, please refer to the Bin and Order Code Formats section (page 6).

Color		CCT / Dominant Wavelength Range			ler codes nous Flux 0 mA	Order Code	
		Min.	Max.	Group	Flux (lm)		
	Red	620 nm	630 nm		45.7		
Color +	Green	520 nm	535 nm	C3		87.4	XMLCTW-A0-0000-00C3AAAA1
Cool White	Blue	450 nm	465 nm		13.9	XMLCTW-A0-0000-00CSAAAAT	
	Cool White	5700 K	8000 K		100		
	Red	620 nm	630 nm		45.7		
Color +	Green	520 nm	535 nm	C2	87.4		
Neutral White	Blue	450 nm	465 nm		13.9	XMLCTW-A0-0000-00C2AAAB1	
	Neutral White	3700 K	4300 K		80		

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements and ±0.005 on chromaticity (CCx, CCy) measurements.
- Flux and chromaticity are measured with each LED die connected to independent drive circuits at 350 mA. The flux and chromaticity of each LED die within the XLamp XM-L Color LED package are measured individually.

CHARACTERISTICS - COMPLETE PACKAGE

The following table lists the product characteristics for the XLamp XM-L Color LED package, measured with all LED dies on simultaneously and each LED die connected to independent drive circuits at 350 mA.

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		3.5	
Viewing angle (FWHM)	degrees (°)		130	
ESD classification (HBM per Mil-Std-883D)			Class 2	
LED junction temperature	°C			150



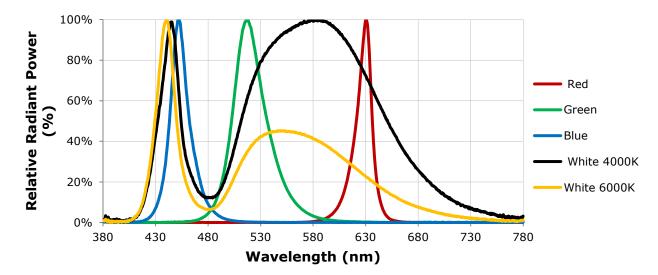
CHARACTERISTICS - PER LED DIE

The following table lists the product characteristics for each LED die within the XLamp XM-L Color LED package.

Characteristics	Unit	Minimum	Typical	Maximum
Temperature coefficient of voltage - red	mV/°C		-1.8	
Temperature coefficient of voltage - green	mV/°C		-4	
Temperature coefficient of voltage - blue, white	mV/°C		-3	
DC forward current - red, green, blue, white	mA			1000
Forward voltage (@ 350 mA, 25 °C) - red	V		2.25	2.6
Forward voltage (@ 350 mA, 25 °C) - green	V		3.3	3.9
Forward voltage (@ 350 mA, 25 °C) - blue, white	V		3.1	3.7

RELATIVE SPECTRAL POWER DISTRIBUTION (I_F = 350 mA PER LED DIE, 25 °C)

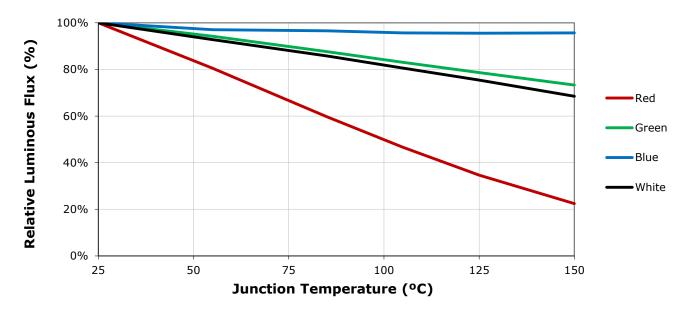
The following graph represents typical spectral output of the XLamp XM-L Color LED with each LED die on independently.





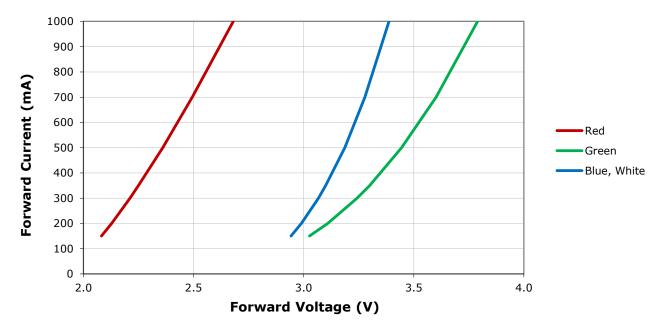
RELATIVE FLUX VS JUNCTION TEMPERATURE (I_F = 350 mA)

The following graph represents typical performance of each LED die in the XLamp XM-L Color LED.



ELECTRICAL CHARACTERISTICS (T₁ = 25 °C)

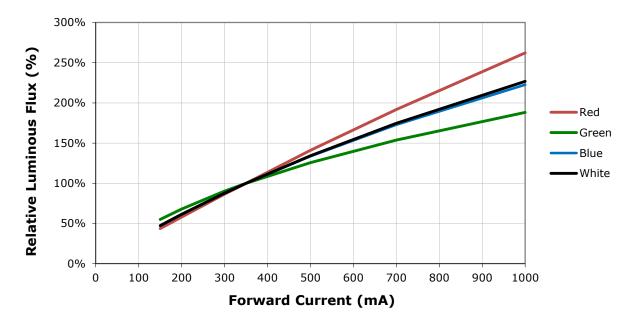
The following graph represents typical performance of each LED die in the XLamp XM-L Color LED.





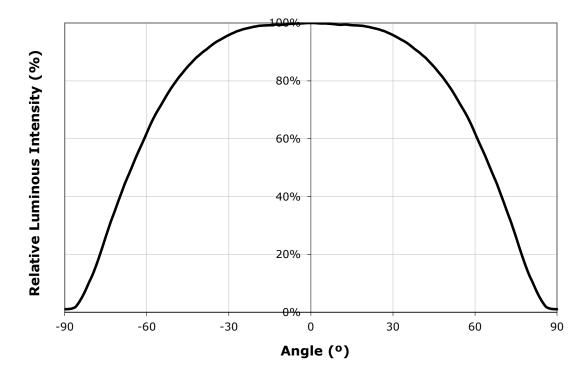
RELATIVE FLUX VS. CURRENT (T₁ = 25 °C)

The following graph represents typical performance of each LED die in the XLamp XM-L Color LED.



TYPICAL SPATIAL DISTRIBUTION

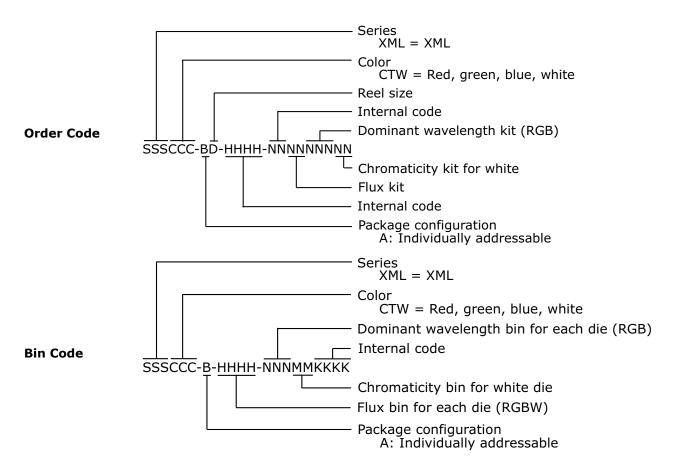
The following graph represents typical output of the XLamp XM-L Color LED with all four LEDs on simultaneously.





BIN AND ORDER-CODE FORMATS

Bin codes and order codes are configured in the following manner:



PERFORMANCE GROUPS – BRIGHTNESS

Each LED die in the XLamp XM-L Color LED is tested individually for luminous flux and placed into one of the following luminous-flux groups.

Color	Group Code	Min. Luminous Flux (Im) @ 350 mA	Max. Luminous Flux (Im) @ 350 mA)
Ded	М	45.7	87.4
Red	N	87.4	114
Green	N	87.4	114
	Р	114	148
Blue	F	13.9	39.8
	2	80	100
White	3	100	120
	4	120	140

• Flux and chromaticity are measured with each LED die connected to independent drive circuits at 350 mA.



PERFORMANCE GROUPS – CHROMATICITY (I_F = 350 mA PER LED DIE)

The white LED die in the XLamp XM-L Color LED is individually tested for chromaticity at 350 mA and placed into one of the regions defined by the bounding coordinates shown below.

Region	x	У	Region	x	У
	.295	.297		.316	.332
WM	.308	.311	WC	.317	.319
VVIII	.310	.300	WC	.308	.311
	.298	.288		.306	.322
	.306	.322		.314	.355
WB	.308	.311	WF	.316	.332
VVD	.295	.297	VVF	.306	.322
	.292	.306		.301	.342
	.301	.342		.329	.345
WE	.306	.322	WD	.329	.330
VVL	.292	.306	VVD	.317	.319
	.287	.321		.316	.332
	.308	.311		.329	.369
WN	.317	.319	WG	.329	.345
VVIN	.318	.308		.316	.332
	.310 .300	.314	.355		

Region	x	у	Region	x	у	Region	x	У	Region	х	У
	.3670	.3578		.3702	.3722		.3825	.3798		.3783	.3646
F A	.3702	.3722	ED.	.3736	.3874	FC	.3869	.3958	FD	.3825	.3798
5A	.3825	.3798	5B	.3869	.3958	5C	.4006	.4044	5D	.3950	.3875
	.3783	.3646		.3825	.3798		.3950	.3875		.3898	.3716

PERFORMANCE GROUPS – DOMINANT WAVELENGTH

The red, green and blue LED dies in the XLamp XM-L Color LED are tested individually for dominant wavelength (DWL) and sorted into one of the DWL bins defined below.

Color	DWL Group	Min. DWL @ 350 mA	Max. DWL @ 350 mA
	К	450	455
Blue	L	455	460
	М	460	465
	2	520	525
Green	3	525	530
	4	530	535
Red	А	620	630



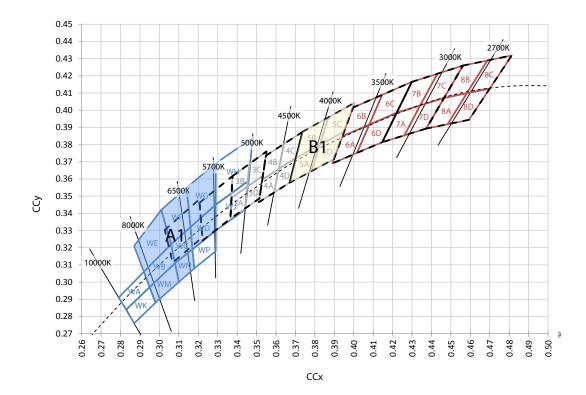
STANDARD ORDER CODES AND BINS

The following tables list standard kit numbers and performance bins. Kit numbers completely describe an order code's color or chromaticity bins and luminous flux range.

XLamp XM-L Color LED Standard Order Codes								
Color	Minimum Luminous Flux Color (lm) @ 350 mA*		DWL / Chromaticity Bins	Kit Number				
	Group	Flux (lm)						
Red	М	45.7	А					
Green	N	87.4	2, 3, 4	00C3AAAA1				
Blue	F	13.9	K, L, M	UUCSAAAAI				
White	3	100	WC, WD, WF, WG, WB, WE, WM, WN					
Red	М	45.7	А					
Green	N	87.4	2, 3, 4	000004481				
Blue	F	13.9	K, L, M	00C2AAAB1				
White	2	80	5A, 5B, 5C, 5D					

For other flux and chromaticity combinations, contact Cree or an authorized distributor.

* Cree XLamp XM-L Color order codes specify only a minimum flux bin and not a maximum. Cree may ship reels in flux bins higher than the minimum specified by the order code without advance notice. Shipments will always adhere to the chromaticity or DWL bin restrictions specified by the order code.



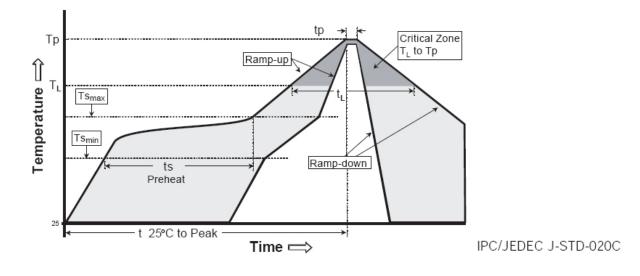
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REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XM-L Color LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.

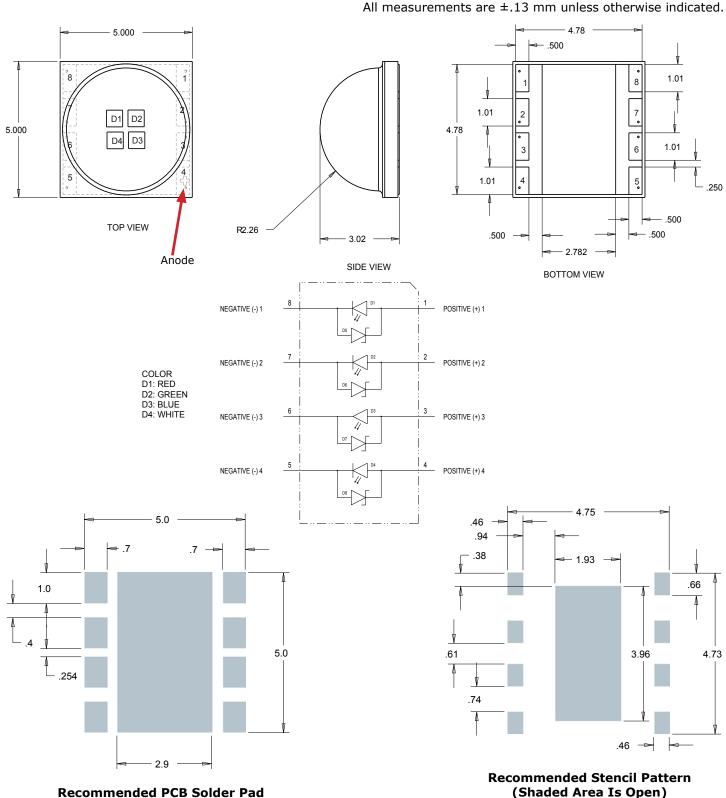


Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts _{min})	100 °C	150 °C
Preheat: Temperature Max (Ts _{max})	150 °C	200 °C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time (t_L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to the topside of the package, measured on the package body surface.



MECHANICAL DIMENSIONS



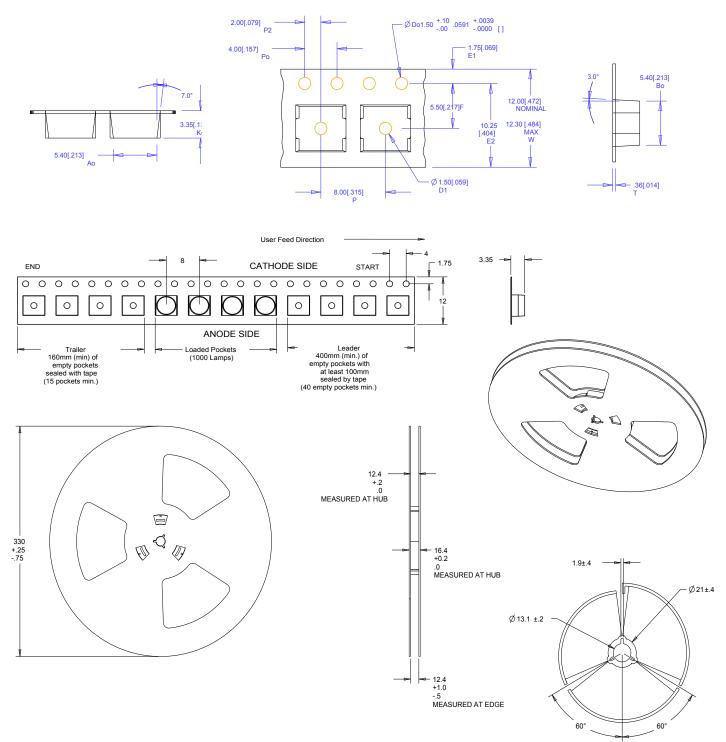
Recommended PCB Solder Pad



TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

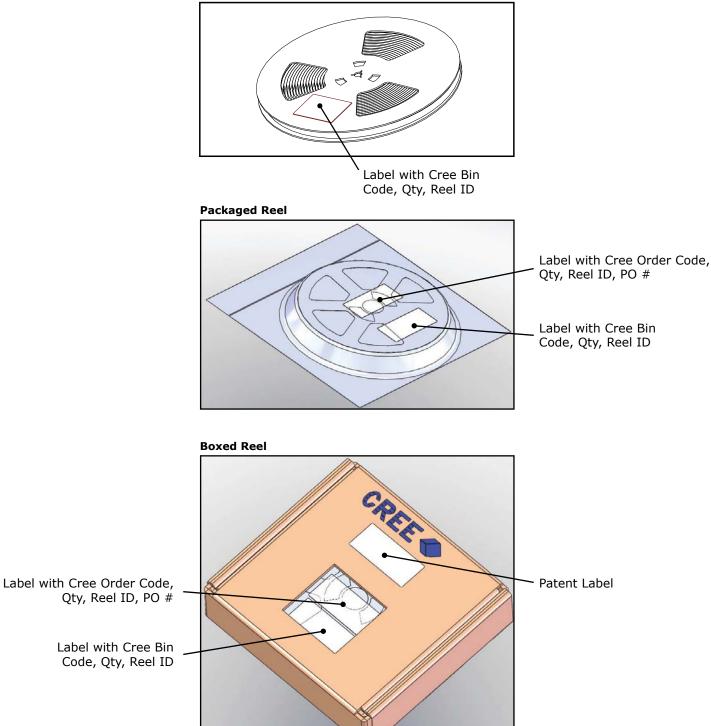
All dimensions in mm.





PACKAGING





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